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Vishay Siliconix

N-Channel 200 V (D-S) 175 °C MOSFET



| PRODUCT SUMMARY | | | | |
|--|--------|--|--|--|
| V _{DS} (V) | 200 | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$ | 0.0375 | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 7.5 \text{ V}$ | 0.0422 | | | |
| Q _g typ. (nC) | 21 | | | |
| I _D (A) | 35.1 | | | |
| Configuration | Single | | | |

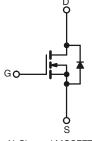
FEATURES

- ThunderFET® power MOSFET
- Low R_{DS} Q_g figure-of-merit (FOM)
- Maximum 175 °C junction temperature
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- · Synchronous rectification
- Power supplies
- DC/AC inverter
- DC/DC converter
- · Solar micro inverter
- Motor drive switch



N-Channel MOSFET

| ORDERING INFORMATION | | | |
|---------------------------------|---------------|--|--|
| Package | TO-220AB | | |
| Lead (Pb)-free and halogen-free | SUP90330E-GE3 | | |

| ABSOLUTE MAXIMUM RATI | NGS (T _A = 25 °C, u | ınless otherv | vise noted) | |
|--|---------------------------------------|-----------------------------------|-------------------|------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Drain-source voltage | | V _{DS} | 200 | V |
| Gate-source voltage | | V_{GS} | ± 20 | V |
| Continuous drain current | T _C = 25 °C | | 35.8 | |
| | T _C = 125 °C | l _D | 20.7 | |
| Pulsed drain current (t = 100 μs) | | I _{DM} | 70 | Α |
| Continuous source-drain diode current | | I _S | 12.5 | |
| Single pulse avalanche current ^a | . 0.411 | I _{AS} | 33 | |
| Single pulse avalanche energy ^a | L = 0.1 mH | E _{AS} | 54.45 | mJ |
| Maximum power dissipation | T _C = 25 °C | | 125 ^b | 14/ |
| | T _C = 125 °C | P _D | 41.7 ^b | W |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +175 | %0 |
| Soldering recommendations (peak temperature) c | | | 260 | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|--------------|-------------------|---------|------|--|
| PARAMETER | | SYMBOL | MAXIMUM | UNIT | |
| Maximum junction-to-ambient (PCB mount) c | | R _{thJA} | 40 | °C/W | |
| Maximum junction-to-case (drain) | Steady state | R _{thJC} | 1.2 | C/VV | |

Notes

- a. Duty cycle ≤ 1 %
- b. See SOA curve for voltage derating
- c. When mounted on 1" square PCB (FR4 material)



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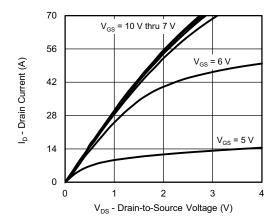
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|--|----------------------|---|------|--------|--------|-----------|--|
| Static | | | | | | | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 200 | - | - | V | |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2 | - | 4 | V | |
| Gate-source leakage | I_{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | - | - | 250 | nA | |
| | | V _{DS} = 200 V, V _{GS} = 0 V | | 1 | | | |
| Zero gate voltage drain current | I_{DSS} | V_{DS} = 200 V, V_{GS} = 0 V, T_J = 125 °C | - | - | 150 | μA | |
| | | V_{DS} = 200 V, V_{GS} = 0 V, T_J = 175 °C | - | - | 5 | mA | |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$ | 20 | - | - | Α | |
| Drain-source on-state resistance a | В | V _{GS} = 10 V, I _D = 12.2 A | - | 0.0312 | 0.0375 | Ο. | |
| Dialii-Source oii-state resistance " | R _{DS(on)} | $V_{GS} = 7.5 \text{ V}, I_D = 11.5 \text{ A}$ | - | 0.0337 | 0.0422 | | |
| Forward transconductance ^a | 9 _{fs} | $V_{DS} = 15 \text{ V}, I_D = 10 \text{ A}$ | - | 28 | - | S | |
| Dynamic ^b | | | | | | | |
| Input capacitance | C _{iss} | | - | 1172 | - | pF | |
| Output capacitance | C _{oss} | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | - | 150 | - | | |
| Reverse transfer capacitance | C _{rss} | | - | 11 | - | | |
| Total gate charge | Q_g | | - | 21 | 32 | nC | |
| Gate-source charge | Q_{gs} | $V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12.2 \text{ A}$ | - | 6 | - | | |
| Gate-drain charge | Q_{gd} | | - | 5.3 | - | | |
| Gate resistance | R_{g} | f = 1 MHz | 0.76 | 3.8 | 7.6 | Ω | |
| Turn-on delay time | t _{d(on)} | | - | 12 | 24 | | |
| Rise time | t _r | V_{DD} = 100 V, R_L = 14.2 Ω , $I_D \cong 7$ A, | - | 25 | 50 | no | |
| Turn-off delay time | t _{d(off)} | $V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | - | 30 | 50 | - ns - | |
| Fall time | t _f | | - | 22 | 44 | | |
| Drain-Source Body Diode Characteristi | cs | | | | | | |
| Pulse diode forward current (t = 100 μs) | I _{SM} | | - | - | 70 | Α | |
| Body diode voltage | V_{SD} | I _F = 7 A, V _{GS} = 0 V | - | 0.8 | 1.5 | V | |
| Body diode reverse recovery time | t _{rr} | | - | 111 | 170 | ns | |
| Body diode reverse recovery charge | Q _{rr} | I _F = 7 A, di/dt = 100 A/μs | - | 0.51 | 1 | μC | |
| Reverse recovery fall time | t _a | i _F = 7 A, αί/αι = 100 A/μs | - | 94 | - | | |
| Reverse recovery rise time | t _b | | - | 17 | - | ns | |
| Body diode peak reverse recovery charge | I _{RM(REC)} | | - | 8.5 | 17 | Α | |

Notes

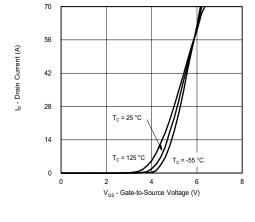
- a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

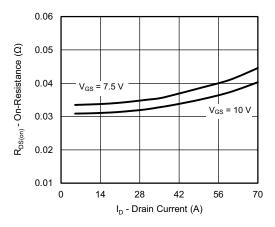




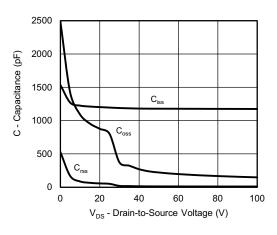
Output Characteristics



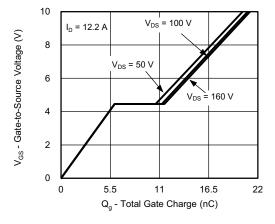
Transfer Characteristics



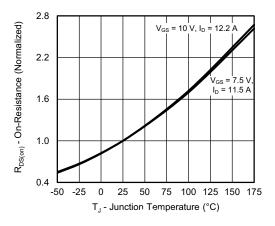
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

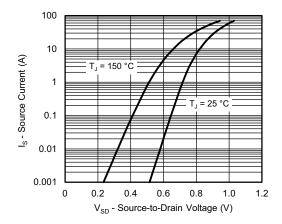


Gate Charge

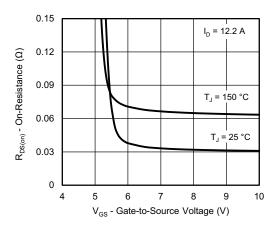


On-Resistance vs. Junction Temperature

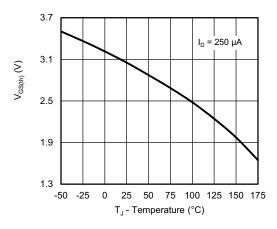




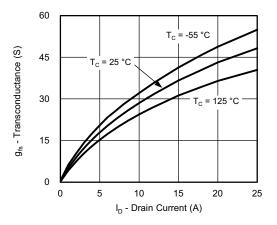
Source-Drain Diode Forward Voltage



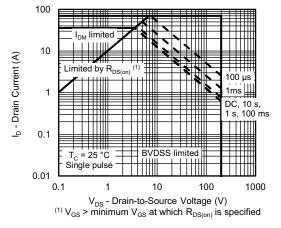
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

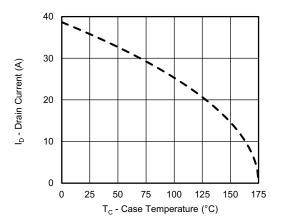


Transconductance

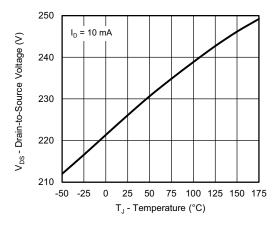


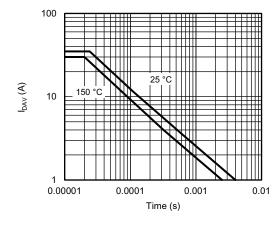
Safe Operating Area, Junction-to-Ambient





Current Derating a



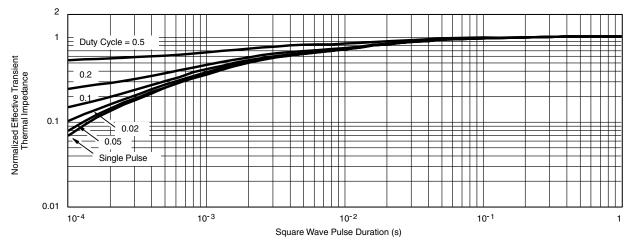


Drain Source Breakdown vs. Junction Temperature

Avalanche vs. Time

Note

a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74528.



Vishay Siliconix

TO-220AB



| | D2 |
|--|----|
| | |
| | |

| | MILLIMETERS | | INC | HES | |
|--|-------------|-------|-------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| А | 4.25 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.01 | 0.027 | 0.040 | |
| b(1) | 1.20 | 1.73 | 0.047 | 0.068 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.85 | 15.49 | 0.585 | 0.610 | |
| D2 | 12.19 | 12.70 | 0.480 | 0.500 | |
| Е | 10.04 | 10.51 | 0.395 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.09 | 6.48 | 0.240 | 0.255 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.35 | 14.02 | 0.526 | 0.552 | |
| L(1) | 3.32 | 3.82 | 0.131 | 0.150 | |
| ØΡ | 3.54 | 3.94 | 0.139 | 0.155 | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | |
| ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471 | | | | | |

Note

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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